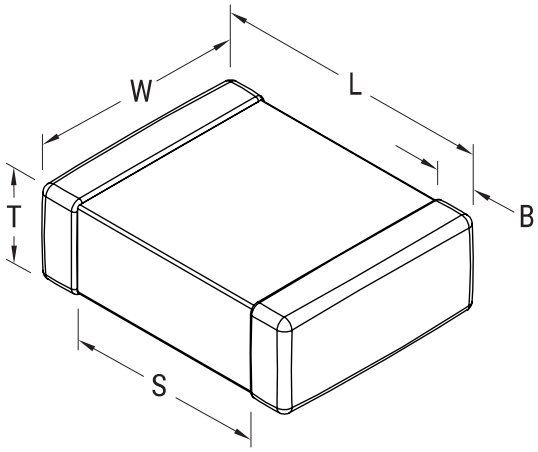
# C1206C470G3TAC7210

SMD Comm X8G HT150C, Ceramic, 47 pF, 2%, 25 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1206 / 3216




Click here for the 3D model.

| General Information | |
|---|---|
| Series | SMD Comm X8G HT150C |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| Typical Component Weight | 17 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|---|---|
| L | 3.2mm +/-0.2mm |
| W | 1.6mm +/-0.2mm |
| T | 0.78mm +/-0.10mm |
| S | 1.5mm MIN |
| B | 0.5mm +/-0.25mm |
| Case Code (EIA / mm) | 1206 / 3216 |

| Packaging Specifications | |
|---|---|
| Packaging | T&R, 330mm, Plastic Tape |
| Packaging Quantity | 10000 |

| Specifications | |
|---|---|
| Capacitance | 47 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 2% |
| Voltage DC | 25 VDC |
| Dielectric Withstanding Voltage | 62.5 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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